

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	50542	chemical adj mechanical adj polish\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/05 10:26
S2	500	205/222.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:40
S3	164	205/222.ccls. and copper	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:40
S4	95	205/222.ccls. and copper and (polish\$3 planar\$7)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:41
S5	36	205/222.ccls. and copper and (polish\$3 planar\$7) and pad	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:41
S6	24	205/222.ccls. and copper and (polish\$3 planar\$7) and pad and seed\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:41
S7	14	205/222.ccls. and copper and (polish\$3 planar\$7) and pad and seed\$3 and slurry	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/05 14:32
S8	32	("5911619" "6103628" "6110011" "6176992" "6197181" "6251235" "6258223" "6299741" "6328872" "6352623" "6355153" "6379223" "6402925" "6409904" "6413388" "6413403").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/05 11:37

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S9	14	205/222.ccls. and copper and (polish\$3 planar\$7) and pad and seed\$3 and slurry	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/05 12:11
S10	12	S9 not S8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/05 10:30
S11	44	S10 S8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/05 10:31
S12	21	laursen-thomas.in. hardikar-vishwas.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/05 11:01
S14	14	205/222.ccls. and copper and (polish\$3 planar\$7) and pad and seed\$3 and slurry and barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/05 14:33
S15	3	205/222.ccls. and copper and (polish\$3 planar\$7) and pad and seed\$3 and slurry and (remove near3 barrier)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/05 14:36
S16	2	205/222.ccls. and ((electrodeposit\$3 electroplat\$3) near3 copper) and (polish\$3 planar\$7) and pad and seed\$3 and slurry and (remove near3 barrier)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/05 14:37
S17	1	205/222.ccls. and ((electrodeposit\$3 electroplat\$3) near3 copper) and (polish\$3 planar\$7) and pad and seed\$3 and slurry and (remove near3 barrier) and (fill\$3 near3 feature)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/05 14:38

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S18	32	((electrodeposit\$3 electroplat\$3) near3 copper) and (polish\$3 planar\$7) and pad and seed\$3 and slurry and (remove near3 barrier) and (fill\$3 near3 feature)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/05 14:47
S19	3	((electrodeposit\$3 electroplat\$3) near3 copper) and (polish\$3 planar\$7) and pad and seed\$3 and slurry and (remove near3 barrier) and (fill\$3 near3 feature) and (barrier near3 selectivity)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/05 14:51
S20	1	((electrodeposit\$3 electroplat\$3) near3 copper) and (polish\$3 planar\$7) and pad and seed\$3 and slurry and (remove near3 barrier) and (fill\$3 near3 feature) and (barrier near3 selectivity) and (1:1 "1 to 1")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/05 14:52
S21	50615	chemical adj mechanical adj polish\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 12:28
S22	379	S21 and (shore near4 hardness)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 12:28
S23	209	S21 and ((shore near4 hardness) with pad)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 12:45
S24	43	S21 and ((shore near4 hardness) with pad) and selectivity	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 12:29
S25	32	S21 and ((shore near4 hardness) with pad) and selectivity and copper	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 12:30

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S26	19	S21 and ((shore near4 hardness) with pad) and selectivity and copper and barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 17:04
S27	3	S21 and ((shore near4 hardness) with pad) and selectivity and copper and barrier and seed	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 12:32
S28	0	S21 and (((shore near4 hardness) near2 ("less than")) with pad)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 12:46
S29	0	S21 and (((shore near4 hardness) near2 ("less near2 than")) with pad)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 12:46
S30	0	S21 and (((shore near4 hardness) near2 (less near2 than)) with pad)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 12:47
S31	76	S21 and (((shore near4 hardness) near3 (less)) with pad)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 13:21
S32	71	S21 and (((shore near4 hardness) near3 (less)) with pad) and copper	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 12:48
S33	37	S21 and (((shore near4 hardness) near3 (less)) with pad) and copper and barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 12:48

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S34	17	S21 and (((shore near4 hardness) near3 (less)) with pad) and copper and barrier and seed	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 12:49
S35	16	S34 not S26	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 12:49
S36	20	S21 and (((shore near4 hardness) near3 (less)) with pad) and politex	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 13:21
S37	20	S21 and (((shore near4 hardness) near3 (less)) with pad) and politex and copper	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 13:22
S38	17	S21 and (((shore near4 hardness) near3 (less)) with pad) and politex and copper and barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 13:22
S39	7	S21 and (((shore near4 hardness) near3 (less)) with pad) and politex and copper and barrier and seed	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 13:22
S40	50615	chemical adj mechanical adj polish\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 16:19
S41	129	((slurry solution fluid) near4 "1:1") and S40	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 16:20

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S42	78	((slurry solution fluid) near4 "1:1") and S40 and copper	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 16:20
S43	47	((slurry solution fluid) near4 "1:1") and S40 and copper and barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 16:20
S44	4	((slurry solution fluid) near4 "1:1") same barrier) and S40 and copper	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 16:22
S45	12	((slurry solution fluid) near4 ("1:1" "1 to 1" "same rate" "one to one")) same barrier) and S40 and copper	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 16:23
S46	50615	chemical adj mechanical adj polish\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 17:04
S47	185	S46 and copper and barrier and (two adj4 slurry)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/06 17:04